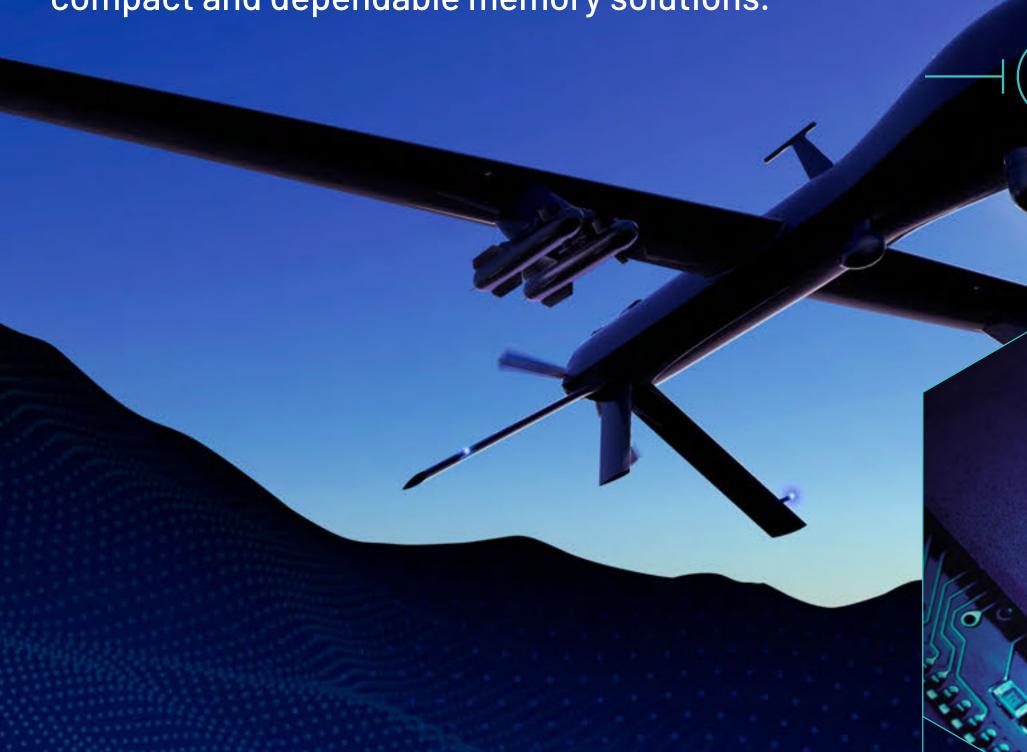
#### HIGH DENSITY DDR

### MEMORY FOR THE TACTICAL EDGE

Processing large volumes of data in rugged environments away from climate-controlled data centers requires compact and dependable memory solutions.



## SPACE IS A PREMIUM FAILURE ISN'T AN OPTION

## TRADITIONAL MEMORY SOLUTIONS JUST WON'T WORK

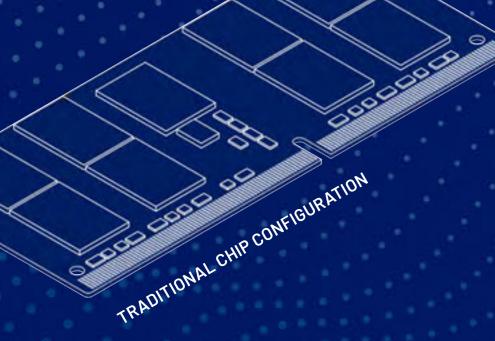
With old chip configurations, individually packaged devices take up too much space Connections likely to fail during vibration

Consumer devices lack a trusted supply chain



Welco.

MAXIMUM PROCESSING
PERFORMANCE IN THE MOST
CHALLENGING ENVIRONMENTS





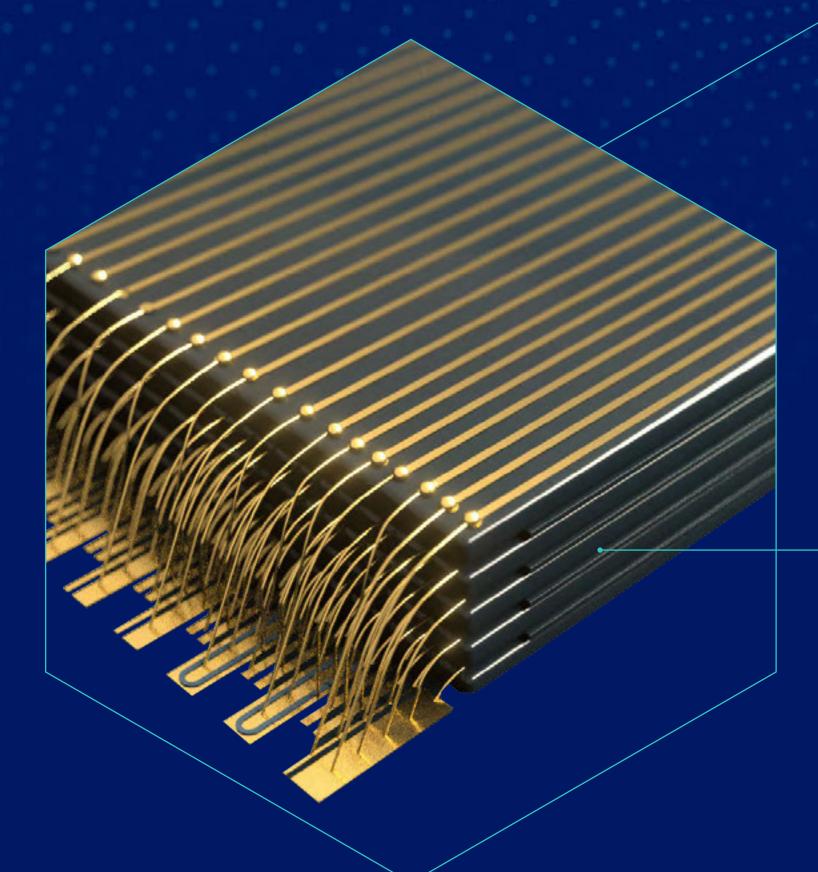
COMPACT



RUGGED







#### PBGA PACKAGE

# WHEN THERE ISN'T ROOM FOR COMPROMISE

Our compact plastic BGA package consisting of multiple stacked die are optimized for size weight and power in military and commercial aerospace applications.

Up to 87%

space savings compared with standard boards

128 mb-16 gb

capacity

100%

burn-in and electrical testing

SHRINK YOUR MEMORY FOOTPRINT

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